

Amendments to the Claims:

This listing of claims will replace all prior versions, and listings, of claims in the application:

Listing of Claims:

Please rewrite claims 8 and 10 as follows:

Claims 1 and 2 (Canceled)

3. (Previously Presented) The piezoelectric/electrostrictive device according to claim 8, wherein said multilayered member is composed of ten or less of said actuator films.

4. (Previously Presented) The piezoelectric/electrostrictive device according to claim 8, wherein each of said actuator films is formed by means of a thick film printing method.

Claim 5 (Canceled)

6. (Previously Presented) The piezoelectric/electrostrictive device according to claim 8, wherein said adhesive has a thickness of not more than 15 μm .

7. (Previously Presented) The piezoelectric/electrostrictive device according to claim 8, further comprising an underlying layer formed on a surface of said piezoelectric/electrostrictive element opposed to a respective one of said thin plate sections.

8. (Currently Amended) A piezoelectric/electrostrictive device comprising:
at least one actuator section including a piezoelectric/electrostrictive element secured onto

thin plate sections made of metal with an adhesive intervening therebetween, said at least one actuator section comprising a multilayered member including at least three or more actuator films each comprising a piezoelectric/electrostrictive layer and electrode films, wherein

| one or more holes ~~or recesses~~ are formed in at least a portion of said thin plate sections
| on which said piezoelectric/electrostrictive element is formed, said one or more holes ~~or~~
| ~~recesses~~ being formed entirely through said thin plate sections in the thickness direction.

9. (Previously Presented) The piezoelectric/electrostrictive device according to claim 8, wherein at least a portion of a surface of each of said thin plate sections, on which said piezoelectric/electrostrictive element is formed, is a rough surface.

10. (Currently Amended) A piezoelectric/electrostrictive device comprising a pair of mutually opposing thin plate sections made of metal and a fixation section for supporting said thin plate sections, and including an actuator section with a stacked type piezoelectric/electrostrictive element fixed on at least one of said thin plate sections by the aid of an adhesive, said stacked type piezoelectric/electrostrictive element comprising a plurality of piezoelectric/electrostrictive layers and electrode films, wherein said electrode films contact upper and lower surfaces of respective piezoelectric/electrostrictive layers and alternately
| extend to opposite end surfaces thereof, wherein said electrode films are substantially
| rectangular having a constant and continuous width dimension and extending fully over a
| width dimension of said respective piezoelectric/electrostrictive layers, and end surface electrodes electrically connect an electrode film that contacts one of said piezoelectric/electrostrictive layers and an electrode film that contacts another one of said

piezoelectric/electrostrictive layers, said end surface electrodes being formed on respective outer side surfaces of said actuator section and being electrically connected to terminals which are provided on a surface of an outermost layer of said piezoelectric/electrostrictive layers and arranged substantially co-planar with respect to one another, said terminals being separated from one another by a predetermined distance.

11. (Original) The piezoelectric/electrostrictive device according to claim 10, wherein said stacked type piezoelectric/electrostrictive element has a substantially rectangular parallelepiped-shaped configuration.

12. (Original) The piezoelectric/electrostrictive device according to claim 10, wherein said predetermined distance between said terminals is not less than 50 μm .

13. (Original) The piezoelectric/electrostrictive device according to claim 10, wherein at least one of said terminals and one of said end surface electrodes are electrically connected with each other with an electrode film having a film thickness which is thinner than those of said terminal and said end surface electrode.

14. (Previously Presented) A piezoelectric/electrostrictive device comprising:

a pair of mutually opposing thin plate sections, and a fixation section for supporting said thin plate sections; and

one or more piezoelectric/electrostrictive elements arranged on at least one thin plate section of said pair of thin plate sections, wherein

a minimum resonance frequency of said piezoelectric/electrostrictive device structure, which is obtained when an object member having a size substantially equivalent to that of said fixation section exists between open ends of said pair of thin plate sections, is not less than 20 kHz, and a relative displacement amount between said object member and said fixation section is not less than 0.5 μm at a substantial applied voltage of 30 V at a frequency which is not more than 1/4 of said resonance frequency.

15. (Previously Presented) The piezoelectric/electrostrictive device according to claim 14, further comprising an adhesive intervening between said piezoelectric/electrostrictive element and said at least one thin plate section, said adhesive having a thickness which is not more than 10 % of a thickness of said piezoelectric/electrostrictive element.

16. (Previously Presented) The piezoelectric/electrostrictive device according to claim 14, wherein said one or more piezoelectric/electrostrictive elements are arranged on one thin plate section of said pair of thin plate sections, and a thickness of said one thin plate section is thicker than a thickness of the other thin plate section.

17. (Previously Presented) The piezoelectric/electrostrictive device according to claim 14, wherein said object member intervenes between said open ends of said pair of thin plate sections, and a distance of said pair of thin plate sections between a boundary portion of said object member and a boundary portion of said fixation section is not less than 0.4 mm and not more than 2 mm, and each of said pair of thin plate sections has a thickness which is not less than 10 μm and not more than 100 μm .

18. (Previously Presented) The piezoelectric/electrostrictive device according to claim 14, wherein said piezoelectric/electrostrictive element comprises a multilayered member including at least three or more actuator films comprising piezoelectric/electrostrictive layers and electrode films.

19. (Previously Presented) The piezoelectric/electrostrictive device according to claim 18, wherein said piezoelectric/electrostrictive element comprises said multilayered member having ten or less actuator films.

20. (Original) The piezoelectric/electrostrictive device according to claim 18, wherein said piezoelectric/electrostrictive layer has a thickness which is not less than 5 μm and not more than 30 μm .

21. (Original) The piezoelectric/electrostrictive device according to claim 18, wherein said electrode film, which is interposed at least between said piezoelectric/electrostrictive layers, has a thickness which is not less than 0.5 μm and not more than 20 μm .

22. (Previously Presented) The piezoelectric/electrostrictive device according to claim 18, wherein said plurality of electrode films, which are included in said multilayered member for constructing said piezoelectric/electrostrictive element, are stacked alternately, and are connected so that an identical voltage is applied to every other electrode layer.

23. (Original) The piezoelectric/electrostrictive device according to claim 22, wherein said piezoelectric/ electrostrictive element is formed such that only a first piezoelectric/electrostrictive layer, or both of a first electrode film and a first piezoelectric/electrostrictive layer of the multilayered member for constructing the piezoelectric/electrostrictive element make contact with said thin plate section.

24. (Previously Presented) The piezoelectric/electrostrictive device according to claim 22, wherein one end of said electrode layer is formed at a position not including at least said fixation section as viewed in plan view.

25. (Original) The piezoelectric/electrostrictive device according to claim 18, wherein an end of said multilayered member for constructing said piezoelectric/electrostrictive element is formed at a position not including at least said fixation section as viewed in plan view.

26. (Previously Presented) The piezoelectric/electrostrictive device according to claim 24, wherein said object member intervenes between said open ends of said pair of thin plate sections, and $(1 - L_b/L_a)$ is not less than 0.4, wherein,

L_a represents a shortest distance of said pair of thin plate sections between a boundary portion of said object member and a boundary portion of said fixation section, and

L_b represents a shortest distance of said thin plate section on which said multilayered member is not formed from one of said object member and fixation member boundary portions between said thin plate sections to an end of said electrode film.

27. (Original) The piezoelectric/electrostrictive device according to claim 26, wherein (1 - Lb/La) is 0.5 to 0.8.

28. (Previously Presented) The piezoelectric/electrostrictive device according to claim 14, wherein said thin plate sections comprise a metal.

29. (Previously Presented) The piezoelectric/electrostrictive device according to claim 28, wherein said thin plate sections comprise a metal plate subjected to a cold rolling process.

30. (Previously Presented) The piezoelectric/electrostrictive device according to claim 18, further comprising an adhesive having a thickness of not less than 0.1 μm and not more than 30 μm intervening between said thin plate sections and said multilayered member for constructing said piezoelectric/electrostrictive element.

31. (Previously Presented) The piezoelectric/electrostrictive device according to claim 30, wherein said adhesive comprises an organic resin.

32. (Previously Presented) The piezoelectric/electrostrictive device according to claim 30, wherein said adhesive comprises glass, brazing material, or solder.

33. (Previously Presented) The piezoelectric/electrostrictive device according to claim 30, further comprising an underlying layer formed on a surface of said multilayered member opposed to a respective one of said thin plate sections.

34. (Previously Presented) The piezoelectric/electrostrictive device according to claim 30, wherein one or more holes or recesses are formed in at least a portion of said thin plate sections on which said multilayered member is formed.

35. (Previously Presented) The piezoelectric/electrostrictive device according to claim 30, wherein at least a portion of a surface of each of said thin plate sections, on which said multilayered member is formed, is a rough surface.

36. (Previously Presented) The piezoelectric/electrostrictive device according to claim 14, further comprising an adhesive having a thickness of not less than 0.1 μm and not more than 30 μm intervening between said thin plate section and at least said fixation section.

37. (Previously Presented) The piezoelectric/electrostrictive device according to claim 36, wherein said adhesive comprises an organic resin.

38. (Previously Presented) The piezoelectric/electrostrictive device according to claim 36, wherein said adhesive comprises glass, brazing material, or solder.

39. (Original) The piezoelectric/electrostrictive device according to claim 36, wherein a stick-out shape of said adhesive, which protrudes from an opposing portion between said thin plate section and at least said fixation section, has a curvature.

40. (Previously Presented) The piezoelectric/electrostrictive device according to claim 36, wherein an object member intervenes between open ends of said pair of thin plate sections, and at least an angular portion of said fixation section opposed to said object member is chamfered.

41. (Previously Presented) The piezoelectric/electrostrictive device according to claim 36, wherein said thin plate section is manufactured by means of stamping of a metal plate, and a burr, which is brought about by said stamping, is directed outwardly.

Claims 42-67 (Cancelled)

68. (Previously Presented) The piezoelectric/electrostrictive device according to claim 10, wherein said actuator section comprises ten or less of said piezoelectric/electrostrictive layers.

69. (Previously Presented) The piezoelectric/electrostrictive device according to claim 10, wherein each of said stacked type piezoelectric/electrostrictive elements is formed by means of a thick film printing method.

70. (Previously Presented) The piezoelectric/electrostrictive device according to claim 10, wherein said adhesive has a thickness of not more than 15 μ m.

71. (Previously Presented) The piezoelectric/electrostrictive device according to claim 10, further comprising an underlying layer formed on a surface of said stacked type

piezoelectric/electrostrictive element opposed to a respective one of said thin plate sections.

72. (Previously Presented) The piezoelectric/electrostrictive device according to claim 10, wherein at least a portion of a surface of each of said thin plate sections, on which said stacked type piezoelectric/electrostrictive element is formed, is a rough surface.

73. (Previously Presented) The piezoelectric/electrostrictive device of claim 10, wherein said end surface electrodes each include a major plane extending substantially perpendicular to planes of said electrode films.